

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild <a href="general-regarding-numbers-n

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



October 2013

DFB2005 - DFB20100 Glass-Passivated Bridge Rectifiers

Features

- UL Certificate: # E258596
- · Glass-Passivated Junction
- · Ideal for Printed Circuit Board
- Reliable Low-Cost Construction
- Plastic Material has Underwriters Laboratory Flammability Classification 94V-0
- Surge Overload Rating to 250 A Peak
- High Case Dielectric Strength: 2000 V_{RMS}
- Isolated Voltage from Case to Lead: > 2500 V



TS-6P

Ordering Informations

| Part Number | Marking | Package | Packing Method |
|-------------|----------|----------|----------------|
| DFB2005 | DFB2005 | | |
| DFB2010 | DFB2010 | | |
| DFB2020 | DFB2020 | | |
| DFB2040 | DFB2040 | TS-6P 4L | Rail |
| DFB2060 | DFB2060 | | |
| DFB2080 | DFB2080 | | |
| DFB20100 | DFB20100 | | |

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

| | | Value | | | | | | | |
|-------------------|--|-------------|-------------|-------------|-------------|-------------|-------------|--------------|-------|
| Symbol | Parameter | DFB 2005 | DFB 2010 | DFB 2020 | DFB 2040 | DFB 2060 | DFB 2080 | DFB 20100 | Units |
| V _{RRM} | Maximum Recurrent Peak Reverse Voltage | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| V _{RMS} | Maximum RMS Voltage | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| V _{DC} | Maximum DC Blocking Voltage | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| I _(AV) | Maximum Average Forward Rectified Current | | | | 20 | | | | Α |
| I _{FSM} | Peak Forward Surge Current (8.3 ms Single Half-wave) | | | | 250 | | | | Α |
| $R_{\theta JC}$ | Typical Thermal Resistance ⁽²⁾ | | | 4.75 | | | | °C/W | |
| TJ | Operating Temperature Range | -55 to | | 55 to +150 | | | °C | | |
| T _{STG} | Storage Temperature Range | | | -55 to +150 | | | | °C | |

Notes:

- 1. Single-phase, half-wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.
- 2. Device mounted on 4 inch x 5 inch x 0.25 inch Al-plate heat sink.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise specified.

| Symbol | Parameter | Test condition | Value | Unit | |
|------------------|---|------------------------|-------|------------------|--|
| V _F | Maximum | 10 A | 1.0 | V | |
| | Instantaneous Forward Voltage | 20 A | 1.1 | | |
| I _R | Maximum DC Reverse Current at Rated DC Blocking Voltage | T _A = 25°C | 10 | μA | |
| | | T _A = 125°C | 500 | μΛ | |
| I ² t | Rating for Fusing (t < 8.3 ms) | | 259 | A ² s | |
| СЛ | Typical Junction Capacitance per L | 140 | pF | | |

Note:

3. Measured at 1 MHz and applied reverse bias of 4.0 V DC.

Typical Performance Characteristics

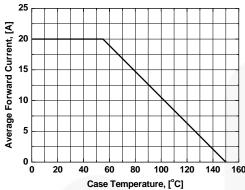


Figure 1. Maximum Derating Curve for Output Current

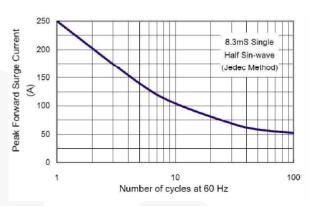


Figure 2. Maximum Forward Surge Current per Leg

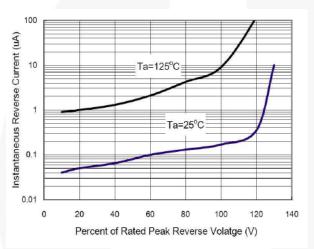


Figure 3. Typical Reverse Characteristics per Leg

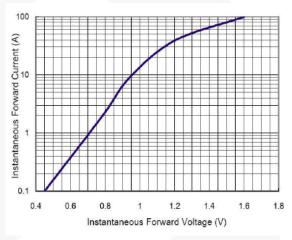


Figure 4. Typical Forward Characteristics per Leg

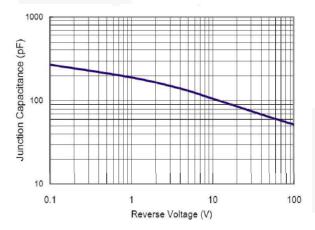
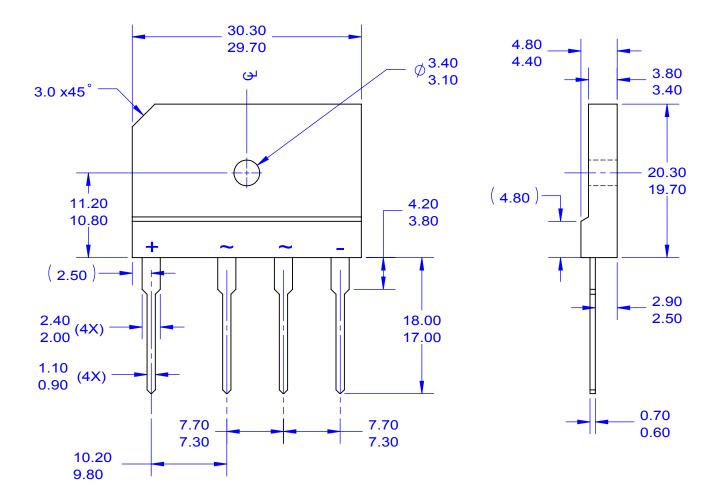


Figure 5. Typical Junction Capacitance



NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO
- ANY STANDARDS.

 B. ALL DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS,
 MOLD FLASH AND TIE BAR PROTRUSIONS.
 D. DRAWING FILE NAME: TS6P04AREV2



ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor:

DFB2040